



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

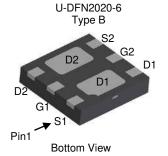
Device	V _{(BR)DSS}	R _{DS(ON)} Max	I _{D Max} T _A = +25°C
0.4		4.0Ω @ V _{GS} = 10V	0.39A
Q1 N-Channel	60V	4.1Ω @ $V_{GS} = 5V$	0.38A
		4.2Ω @ V _{GS} = 4V	0.37A
00		$72m\Omega$ @ $V_{GS} = -4.5 V$	-2.9A
Q2 P-Channel	-20V	$108m\Omega$ @ $V_{GS} = -2.7V$	-2.3A
1 Gridinion		$123m\Omega$ @ $V_{GS} = -2.5V$	-2.2A

Description

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

Load Switch



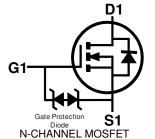


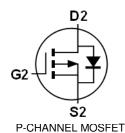
Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- ESD Protected Gate
 - Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: U-DFN2020-6 Type B
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 5)

Part Number	Case	Packaging
DMC67D8UFDBQ-7	U-DFN2020-6 Type B	3000/Tape & Reel
DMC67D8UFDBQ-13	U-DFN2020-6 Type B	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/. 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

7D YWX

A-Z

7D = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 9 = 2019)

W = Week (ex: a = week 27; z represents week 52 and 53)

X = Internal code (ex: U = Monday)

Date Code Key

Code

Year	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	7	8	9	0	1	2	3	4	5
Wook		1_26			27-52			52	

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Υ	Z



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-Channel	Q2 P-Channel	Unit		
Drain-Source Voltage	V_{DSS}	60	-20	V		
Gate-Source Voltage	V_{GSS}	±20	±12	V		
Continuous Drain Current (Note 7) N-Channel: V _{GS} = 10V P-Channel: V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	0.39 0.31	-2.9 -2.3	А
Maximum Continuous Body Diode Forward Current (Note 7)			I _S	0.39	-2.9	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	0.8	-20	Α		
Pulsed Source Current (10µs Pulse, Duty Cycle	= 1%)		I _{SM}	-0.8	-20	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	$T_A = +25$ °C	P_{D}	0.58	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\Theta JA}$	215	°C/W
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$	P_D	0.89	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{\Theta JA}$	140	°C/W
Thermal Resistance, Junction to Case (Note 7)		$R_{\Theta JC}$	35	C/VV
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

Electrical Characteristics: Q1 N-Channel (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_{D} = 10\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μΑ	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	2.5	>	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			1.7	4.0		$V_{GS} = 10V, I_D = 0.5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.6	4.1	Ω	$V_{GS} = 5V, I_D = 0.2A$
			1.8	4.2		$V_{GS} = 4V, I_D = 0.2A$
Diode Forward Voltage	V _{SD}	_	8.0	1.1	٧	V _{GS} = 0V, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}		41	_	рF	V 05V V 0V
Output Capacitance	Coss		4.4		рF	V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		2.6	_	рF	1 - 1.01/11/12
Gate Resistance	R_{g}		900		Ω	$f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$
Total Gate Charge	Qg		0.4	_	рC	V 45V V 40V
Gate-Source Charge	Q _{gs}	_	0.2	_	рC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$
Gate-Drain Charge	Q_{gd}	_	0.1	_	рC	ID = 230IIIA
Turn-On Delay Time	t _{D(ON)}	_	3.7	_	ns	
Turn-On Rise Time	t _R	_	3.6	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time	t _{D(OFF)}	_	102	_	ns	$R_g = 25\Omega$, $I_D = 200mA$
Turn-Off Fall Time	t _F	_	22	_	ns	
Reverse Recovery Time	t _{RR}		20	_	ns	I _F = 1A, di/dt = 100A/μs
Reverse Recovery Charge	Q _{RR}		7.9		nC	I _F = 1A, di/dt = 100A/μs



Electrical Characteristics: Q2 P-Channel (@ TA = +25°C, unless otherwise specified.)

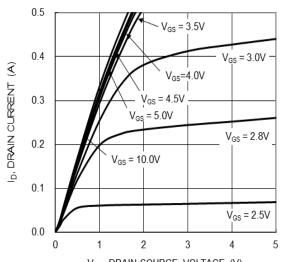
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_		٧	$I_D = -250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Body Leakage Current	Igss	_	_	±100	nA	$V_{DS} = 0V, V_{GS} = \pm 12V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	-0.6		-1.25	>	$V_{DS} = V_{GS}, \ I_D = -250 \mu A$
			51	72		$V_{GS} = -4.5V, I_D = -3.5A$
Static Drain-Source On-Resistance	R _{DS(ON)}		87	108	mΩ	$V_{GS} = -2.7V$, $I_D = -3.0A$
			99	123		$V_{GS} = -2.5V, I_D = -2.6A$
Diode Forward Voltage	V_{SD}	_	-0.79	-1.26	V	$I_S = -1.7A, V_{GS} = 0V$
DYNAMIC PARAMETERS (Note 9)						
Total Gate Charge	Qg		7.3		nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -3.0A$
Gate-Source Charge	Q_{gs}	1	2.0		nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -3.0A$
Gate-Drain Charge	Q_{gd}	1	1.9		nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -3.0A$
Turn-On Delay Time	t _{D(on)}	1	12		ns	
Turn-On Rise Time	tr		20		ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	$t_{D(off)}$	1	38		ns	$R_L = 10\Omega, R_G = 6\Omega$
Turn-Off Fall Time	t _f	1	41		ns	
Input Capacitance	C _{iss}		443	_	pF	V 40V V 0V
Output Capacitance	Coss		128		pF	$V_{DS} = -16V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		101	_	pF	1 - 1.010112

- Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

- 9. Guaranteed by design. Not subject to product testing.



Typical Characteristics: N-Channel



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 1. Typical Output Characteristic

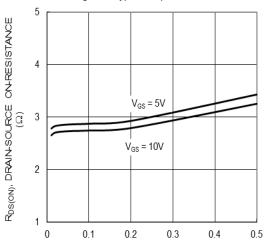


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

ID, DRAIN-SOURCE CURRENT (A)

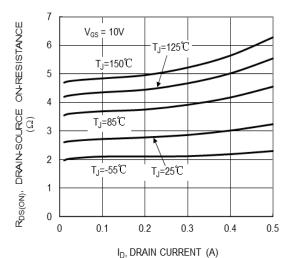
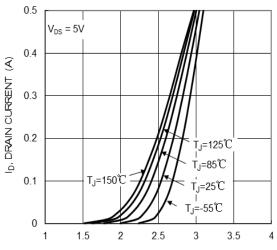
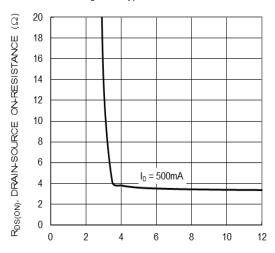


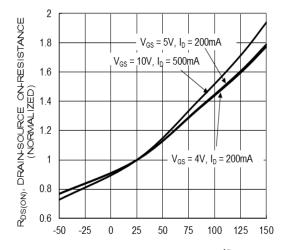
Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 4. Typical Transfer Characteristic



T_J, JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature



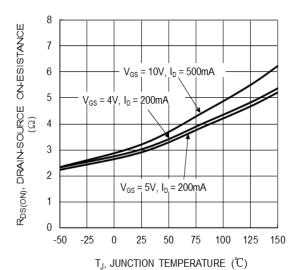
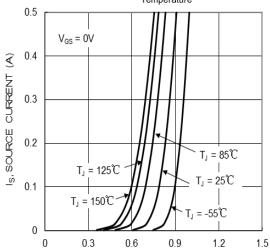


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

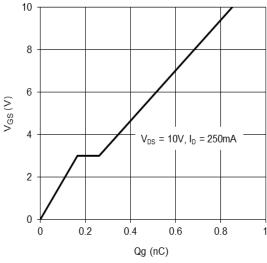


Figure 11. Gate Charge

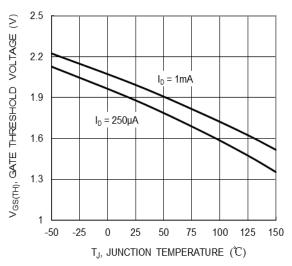
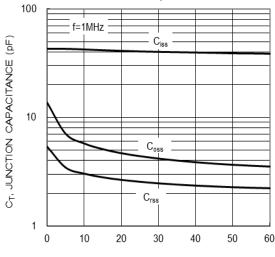
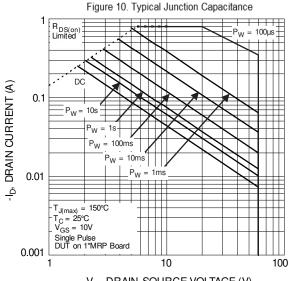


Figure 8. Gate Threshold Variation vs. Junction Temperature



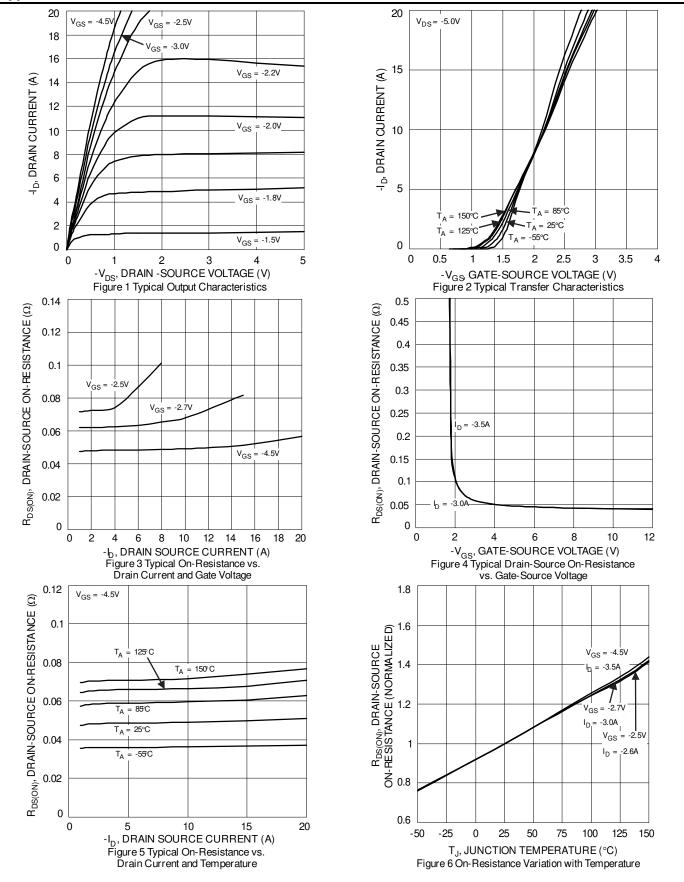
V_{DS}, DRAIN-SOURCE VOLTAGE (V)



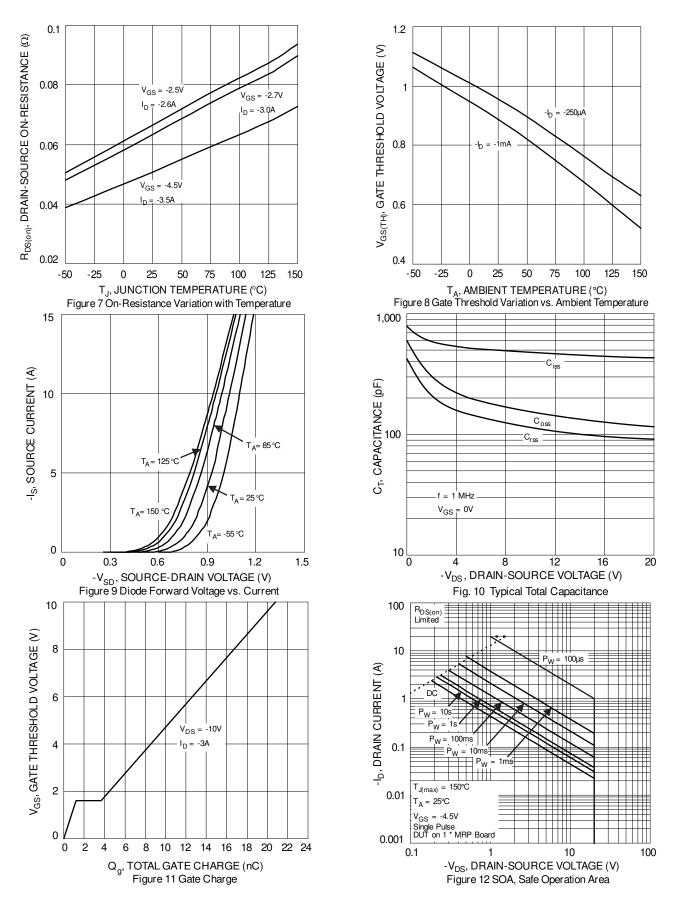
-V_{DS} DRAIN-SOURCE VOLTAGE (V) Figure 12 SOA, Safe Operation Area



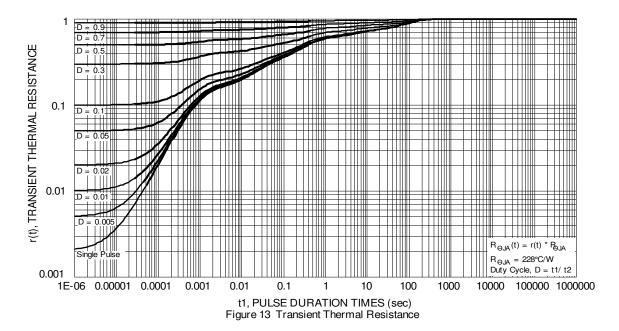
Typical Characteristics: P-Channel







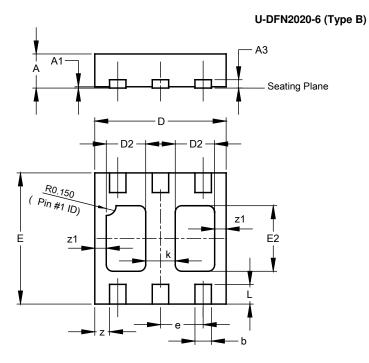






Package Outline Dimensions

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

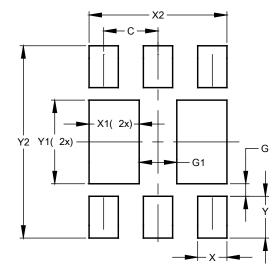


U-DFN2020-6 Type B								
Dim	Min							
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.02					
A3	-	-	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
D2	0.50	0.70	0.60					
е	-	-	0.65					
Е	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
k	-	-	0.45					
L	0.25	0.35	0.30					
Z	-	-	0.225					
z 1	-	-	0.175					
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)			
С	0.650			
G	0.150			
G1	0.450			
X	0.350			
X1	0.600			
X2	1.650			
Y	0.500			
Y1	1.000			
V2	2 300			



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2019, Diodes Incorporated

www.diodes.com